

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	TLD1121EL	**Issued**	08. April 2022
MA#	MA005710279		
Package	PG-SSOP-14-5	**Weight***	82.76 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.376	1.66	1.66	16631	16631
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		104	
	non noble metal	zinc	7440-66-6	0.034	0.04		416	
	non noble metal	iron	7439-89-6	0.689	0.83		8326	
	non noble metal	copper	7440-50-8	27.978	33.81	34.69	338058	346904
wire	non noble metal	copper	7440-50-8	0.074	0.09	0.09	900	900
encapsulation	organic material	carbon black	1333-86-4	0.101	0.12		1217	
	plastics	epoxy resin	-	4.634	5.60		55996	
	inorganic material	silicondioxide	60676-86-0	45.637	55.14	60.86	551439	608652
leadfinish	non noble metal	tin	7440-31-5	0.976	1.18	1.18	11795	11795
plating	noble metal	silver	7440-22-4	0.768	0.93	0.93	9275	9275
glue	plastics	epoxy resin	-	0.121	0.15		1461	
	noble metal	silver	7440-22-4	0.363	0.44	0.59	4382	5843
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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